

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7217142

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SEONGWON LEE	01/27/2022
SEUNGHYUN HWANG	03/02/2022
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129 SAMSUNG-RO, YEONGTONG-GU, SUWON-SI
City:	GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Name:	WOONYOUNG CO., LTD.
Street Address:	2122-20, CHEONAN-DAERO, SEONGHWAN-EUP, SEOBUK-GU, CHEONAN-SI
City:	CHUNGCHONGNAM-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17691246
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	5000-1-2033
NAME OF SUBMITTER:	STEVE CHA
SIGNATURE:	/Steve Cha/
DATE SIGNED:	03/10/2022

Total Attachments: 3

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Assignment of Invention and Patent Application

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration,

1) Seongwon LEE of
129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea

2) Seunghyun HWANG of
2122-20, Cheonan-daero, Seonghwan-eup, Seobuk-gu, Cheonan-si,
Chungcheongnam-do 31022, Republic of Korea

(hereinafter **Assignor**) hereby sells, assigns, transfers, and sets over unto:

SAMSUNG ELECTRONICS CO., LTD. of
129 SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO, 16677
REPUBLIC /OF KOREA

WOONYOUNG CO., LTD. of
2122-20, Cheonan-daero, Seonghwan-eup, Seobuk-gu, Cheonan-si,
Chungcheongnam-do 31022, Republic of Korea

(hereinafter **Assignee**) the entire right, title and interest for the United States Of America and all other countries as defined in 35 U.S.C. Section 261, in and to the invention entitled as:

**ELECTRONIC DEVICE CONTROLLING APPLICATION OF POWER AND
METHOD FOR OPERATING THEREOF**

invented by **Assignor**; the application for United States patent and all other countries, invented by **Assignor**; any patent or reissues of any patent that may be granted thereon; and any applications which are continuations, continuation-in-part, substitutes, or divisions of said application. **Assignor** authorizes **Assignee** to enter the date of signature and/or Serial Number and Filing Date in the above. **Assignor** also authorizes and requests the Commissioner of Patents and Trademarks to issue any resulting patent(s) to the said **Assignee**, for its interests as **Assignee**, its successors, assigns and legal representatives. The undersigned agrees that the attorney of record in said application shall hereafter act on behalf of said **Assignee**; and **Assignor** further conveys to **Assignee** all priority rights resulting from the above-identified application for United States Patent and all other countries. **Assignor** agrees to execute all papers, give any required testimony and perform other lawful acts, as deemed essential by **Assignee** to perfect

Assignee's interest in any resulting patent of the United States and all other countries, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions thereof, and Assignee's interest therein.

SIGNED ON THE DATES(S) INDICATED BESIDE MY/OUR SIGNATURE(S):

Name of First Inventor: Seongwon LEE

Seongwon LEE
Signature of inventor

Dated: January 27, 2022

WITNESSED: _____

Name of Second Inventor: Seunghyun HWANG

Signature of inventor

Dated: _____

WITNESSED: _____

Assignee's interest in any resulting patent of the United States and all other countries, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions thereof, and Assignee's interest therein.

SIGNED ON THE DATES(S) INDICATED BESIDE MY/OUR SIGNATURE(S):

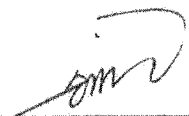
Name of First Inventor: Seongwon LEE

Signature of inventor

Dated: _____

WITNESSED: _____

Name of Second Inventor: Seunghyun HWANG



Signature of inventor

Dated: 2022. 3. 2

WITNESSED: _____